C Microsemi
SCOTTSDALE DIVISION

## MMAD1106 and MMAD1106e3

Switching Diode Array Steering Diode TVS Array™

## DESCRIPTION

These low capacitance diode arrays are multiple, discrete, isolated junctions fabricated by a planar process and mounted in a 14-pin package for use as steering diodes protecting up to eight I/O ports from negative ESD, EFT, or surge by directing them to ground (pin 14)\*. They may also be used in fast switching core-driver applications. This includes computers and peripheral equipment such as magnetic cores, thin-film memories, plated-wire memories, etc., as well as decoding or encoding applications. These arrays offer many advantages of integrated circuits such as high-density packaging and improved reliability. This is a result of fewer pick and place operations, smaller footprint, smaller weight, and elimination of various discrete packages that may not be as user friendly in PC board mounting. They are available with either Tin-Lead plating terminations or as RoHS Compliant with annealed matte-Tin finish by adding an "e3" suffix to the part number.

\*See MMAD1105(e3) for directing positive transients to positive side of the power supply line.

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

#### FEATURES

- 8 Diode Array
- Molded 14-Pin SOIC Package
- UL 94V-0 Flammability Classification
  Low Capacitance 1.5 pF per diode
- Low Capacitance 1.5 pF per diod
- Switching speeds less than 5 ns
- RoHS Compliant devices available by adding "e3" suffix
- IEC 61000-4 compatible
  - 61000-4-2 (ESD): Air 15kV, contact 8 kV 61000-4-4 (EFT): 40A – 5/50 ns
  - 61000-4-5 (surge): 12A, 8/20 μs

### MAXIMUM RATINGS

- Operating Temperature: -55°C to +150°C
- Storage Temperature: -55°C to +150°C
- Forward Surge Current: 2 Amps (8.3 ms)
- 12 Amps (8/20 µs)
- Continuous Forward Current: 400 mA (one diode)
- Power Dissipation (P<sub>D</sub>): 1500 mW (total)

BREAKDOWN

VOLTAGE

V<sub>BR</sub> @ I<sub>BR</sub> =100µA

V

MIN

90

Solder Temperatures: 260°C for 10 s (maximum)

WORKING

PFAK

REVERSE

VOLTAGE

V<sub>RWM</sub>

MAX

75

Top Viewing Pin Layout

APPEARANCE

 $\cap$ 

2

3

4

5

6

7

**APPLICATIONS / BENEFITS** 

Low capacitance steering diode protection for high

MECHANICAL AND PACKAGING

CASE: Void-free transfer molded thermosetting

epoxy body meeting UL94V-0 flammability

TERMINALS: Tin-Lead or RoHS Compliant

MARKING: MSC logo, MMAD1106 or

of the dot or indent on top of package WEIGHT: 0.127 grams (approximate)

Carrier tube packaging: 55 pcs

annealed matte-Tin plating solderable per MIL-

MMAD1106e3 and date code. Pin #1 is to the left

Tape & Reel packaging: 2500 pcs (STANDARD)

REVERSE

RECOVERY

TIME

t.

ns

MAX

5.0

FORWARD

VOLTAGE

V.

 $I_{F} = 10 \text{ mA}$ 

V

MAX

1.00

RS-232 & RS-422 Interface Networks

14

13

12

11

10

9

8

@V<sub>R</sub>

20

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I FAKAGE

CURRENT

T<sub>₄</sub> = 150°C

μA

MAX

300

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless otherwise specified

LEAKAGE

CURRENT

I<sub>R</sub> T₄ = 25°C

μA

@V⊳

20

MAX

0.200

LAN

frequency data lines

Ethernet: 10 Base T

Computer I/O Ports

Switching Core Drivers

STD-750 method 2026

classification

CAPACITANCE

С

@ 0 V

pF

TYP

1.5

PART

NUMBER

MMAD1106

MMAD1106e3

- e3 -

**MMAD1106** 

FORWARD

VOLTAGE

V.

 $I_{\rm F} = 100 \, {\rm mA}$ 

v

MAX

1.20



Switching Diode Array Steering Diode TVS Array™

	SYMBOLS & DEFINITIONS					
Symbol	I Definition					
V <sub>BR</sub>	Minimum Breakdown Voltage: The minimum voltage the device will exhibit at a specified current.					
V <sub>RWM</sub>	Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating temperature range.					
VF	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.					
I <sub>R</sub>	Maximum Leakage Current: The maximum leakage current that will flow at the specified voltage and temperature.					
С	Capacitance: The capacitance of the TVS as defined @ 0 volts at a frequency of 1 MHz and stated in picofarads.					

# **OUTLINE AND CIRCUIT**



	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.336	0.344	8.53	8.74
В	0.150	0.158	3.81	4.01
С	0.053	0.069	1.35	1.75
D	0.011	0.021	0.28	0.53
F	0.016	0.050	0.41	1.27
G	0.050 BSC		01.27 BSC	
J	0.006	0.010	0.15	0.25
K	0.004	0.008	0.10	0.20
L	0.189	0.206	4.80	5.23
Р	0.228	0.244	5.79	6.19

## OUTLINE





CIRCUIT CONFIGURATION